Rev. 3-21-01 Effective March 1998

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original () Supplemental () Substitute () PCT () DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: POLISHING APPARATUS INCLUDING TURNTABLE WITH POLISHING SURFACE OF DIFFERENT HEIGHTS

of which is described and claimed in:

() the attached specification, or

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(X) the specification in the reissue application of U.S. Patent 5,888,126 filed March 30, 2001 and with amendments through March 30, 2001;

() the specification in International Application No., filed, and as amended on (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	28722/1995	January 25, 1995	YES
Japan	206594/1995	July 20, 1995	YES

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

We believe that original U.S. Patent 5,888,126 to be partly inoperative by reason of oursclaiming less than we had a right to claim in the patent.

As at least one error which is relied upon to support this reissue application, we believe that we have a right to a claim of the scope according to new claim 22 directed to an apparatus for polishing a semiconductor wafer, the apparatus comprising an abrasive cloth and a top ring, wherein a plurality of portions of the abrasive cloth are individually and independently pressed against the wafer by air pressures. As compared with apparatus claims 1, 3, 4, 5, 6, 13, 19 and 21 of the patent, claim 22 does not require a moving means as recited, for example, in addition to further separate and individual differences between claim 22 and the various independent claims of the patent.

All errors being corrected in this reissue application, up to the time of the filing of this reissue Declaration, arose without any deceptive intention on the part of the Applicants.

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from <u>WATANABE & HOTTA</u> as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to Customer No:

000513

PATENT TRADEMARK OFFICE

Direct Telephone Calls to:

WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021

Phone:(202) 721-8200 Fax:(202) 721-8250

	Full Name of First Inventor	FAMILY NAME FIRST GIVEN NAME HIROSE Masayoshi	SECOND GIVEN NAME	
	Residence & Citizenship	city state or country Yokohama-shi Japan	country of citizenship Japan	
	Post Office Address	ADDRESS CITY 3207-747, 3-2-3 Shiomidai, Isogo-ku,	state or country zip code Yokohama-shi, Kanagawa-ken, Japan	
E C	Full Name of Second Inventor	FAMILY NAME FIRST GIVEN NAME SASAKI Yoshimi	SECOND GIVEN NAME	
-	Residence & Citizenship	city state or country Atsugi-shi Japan	country of citizenship Japan	
	Post Office Address	st Office ADDRESS CITY STATE OR COUNTRY ZIP CODE		
	Full Name of Third Inventor	FAMILY NAME FIRST GIVEN NAME OGATA Akira	SECOND GIVEN NAME	
	Residence & Citizenship	city state or country Yokohama-shi Japan	country of citizenship Japan	
	Post Office Address	ADDRESS CITY STATE OR COUNTRY ZIP CODE 4-14-31, Nakashirane, Asahi-ku, Yokohama-shi, Kanagawa-ken, Jap		
	Full Name of Fourth Inventor	FAMILY NAME FIRST GIVEN NAME ISHIKAWA Seiji	SECOND GIVEN NAME	
	Residence & Citizenship	city state or country Yokohama-shi Japan	country of citizenship Japan	
	Post Office Address	ADDRESS CITY STATE OR COUNTRY ZIP CODE 2415-108 Naracho, Aoba-ku, Yokohama-shi, Kanagawa-ken, Japan		
	Full Name of Fifth Inventor	FAMILY NAME FIRST GIVEN NAME TAKAHASHI Tamami	SECOND GIVEN NAME	

Residence & Citizenship	Yamato-shi	state or country Japan	country of citizensiiip Japan
Post Office	ADDRESS	спу	state or country zip cobe
Address	2-7-27-101 Yam	atohigashi, Yamato-	shi, Kanagawa-ken, Japan
Full Name of	FAMILY NAME	first given name	SECOND GIVEN NAME
Sixth Inventor	HIYAMA	Hirokuni	
Residence & Citizenship	сіту Tokyo	state or country Japan	country of citizenship Japan
Post Office	ADDRESS	ciry	state or country zip code
Address	3-31-1 Kyodo, S	etagaya-ku, Tokyo,	Japan
Full Name of Seventh Inventor	FAMILY NAME WADA	first given name Yutaka	SECOND GIVEN NAME
Residence &	сіту	state or country	country of citizenship Japan
Citizenship	Yokohama-shi	Japan	
Post Office	ADDRESS	сіту	state or country zip code
Address	3204-446, 3-2-3	Shiomidai, Isogo-ku	, Yokohama-shi, Kanagawa-ken, Japan

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor		Date	
Mas	ayoshi HIROSE		
2nd Inventor		Date _	
Yos	himi SASAKI		
3rd Inventor		Date _	
	ra OGATA		
4th Inventor		Date	
	i ISHIKAWA		
5th Inventor		Date	
Tan	nami TAKAHASHI		
6th Inventor		Date _	
	okuni HIYAMA		
7th Inventor		Date _	
	aka WADA		·

The above application may be more particularly identified as follows:

U.S. Application Serial No. NEW Filing Date March 30, 2001

CHS CIBBOA

Applicant Reference Number <u>GEB240-US-Reissue</u> Atty Docket No. <u>2001-0386</u>

Title of Invention POLISHING APPARATUS INCLUDING TURNTABLE WITH POLISHING SURFACE OF DIFFERENT HEIGHTS